

Correspondence and Mail

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"Reply under 37 CFR 1.116
--Expedited Procedure--
Examining Group 2823

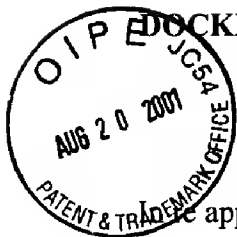
AT-12823

#18 / *Amend B*
PATENT

Amend B
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DOCKET NO.: MERCHANT 33-3-3

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re application of:

Sailesh Merchant, *et. al.*

Serial No.: 09/092,158

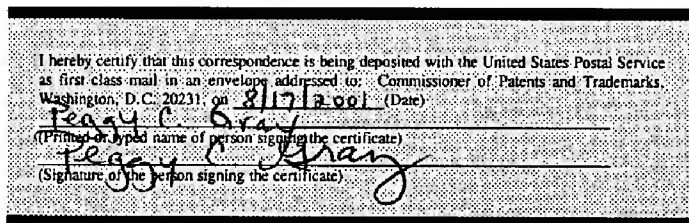
Filed: June 5, 1998

For: METHOD FOR THE FABRICATION OF CONTACTS IN AN
INTEGRATED CIRCUIT DEVICE

Grp./A.U.: 2823

Examiner: Eaton, K.

Honorable Commissioner of Patents
Washington, D.C. 20231



Sir:

AMENDMENT UNDER 37 C.F.R. § 1.116

In response to the Examiner's Action mailed June 20, 2001, please amend the above-identified application as follows:

IN THE CLAIMS:

(1) Kindly amend Claim 1 as follows:

1. (Twice Amended) A process for fabricating a contact in a semiconductor substrate having a contact opening formed therein, comprising:

Sub B